

2MBI300VE-170-50

IGBT Modules

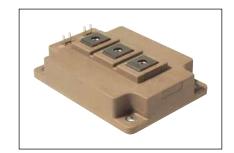
IGBT MODULE (V series) 1700V / 300A / 2 in one package

Features

High speed switching Voltage drive Low Inductance module structure

Applications

Inverter for Motor Drive AC and DC Servo Drive Amplifier Uninterruptible Power Supply Industrial machines, such as Welding machines



Maximum Ratings and Characteristics

■ Absolute Maximum Ratings (at Tc=25°C unless otherwise specified)

Items		Symbols	Conditions	'	Maximum ratings	Units	
Collector-Emitter voltage	Collector-Emitter voltage				1700	V	
Gate-Emitter voltage		V _{GES}			±20	V	
Collector current		Ic	Continuous	Tc=100°C	300		
			Continuous	Tc=25°C	440		
		Ic pulse	1ms		600		
		-lc					
		-lc pulse	1ms	1ms			
Collector power dissipation		Pc	1 device		2830	W	
Junction temperature		Tj			175		
Operating junction temperature (under switching conditions)		T _{jop}				°C	
Case temperature		Tc			125	C	
Storage temperature		T _{stg}			-40 ~ +125		
Isolation voltage between terminal and copper base (*1)		Viso	AC: 1min.		4000	VAC	
Sarous torque Mounting (*2	Mounting (*2)					N m	
Screw torque Terminals (*3)		7-				IN III	

Note *1: All terminals should be connected together during the test. Note *2: Recommendable Value : 3.0-6.0 Nm (M5 or M6) Note *3: Recommendable Value : 2.5-5.0 Nm (M6)

● Electrical characteristics (at Tj= 25°C unless otherwise specified)

	Comple a la	Conditions		Characteristics			Units	
ems	Symbols			min.	typ.	max.	Units	
Zero gate voltage collector current	Ices	V _{GE} = 0V, V _{CE} = 1700V		-	-	2.0	mA	
Gate-Emitter leakage current	Iges	$V_{CE} = 0V, V_{GE} = \pm 20V$		-	-	800	nA	
Gate-Emitter threshold voltage	V _{GE (th)}	V _{CE} = 20V, I _C = 300mA		6.0	6.5	7.0	V	
	\v	V _{GE} = 15V I _C = 300A	Tj=25°C	-	2.15	2.60	V	
	V _{CE (sat)} (terminal)		Tj=125°C	-	2.55	-		
Collector-Emitter saturation voltage	(terrillial)		Tj=150°C	-	2.60	-		
Conector-Emitter Saturation voltage	V _{CE (sat)}		Tj=25°C	-	2.00	2.25		
	(chip)		Tj=125°C	-	2.40	-		
	(Gnip)		Tj=150°C	-	2.45	-		
Internal gate resistance	R _{g(int)}	<u> </u> -		-	2.5	-	Ω	
Input capacitance Turn-on time	Cies	$V_{CE} = 10V$, $V_{GE} = 0V$, $f = 1MHz$		-	33	-	nF	
Turn-on time	ton	V _{cc} = 900V Tj = 150°C I _c = 300A L _s = 30nH		-	1150	-	nsec	
	tr			-	580	-		
	tr (i)	V _{GE} = ±15V	-	60	-			
Turn-off time	toff	$R_{G_on} = 4.7\Omega$		-	1050	-		
Turn-on time	tf	$R_{G_{off}} = 2.4\Omega \qquad - 140$				-]	
	VF	V _{GE} = 0V I _F = 300A	Tj=25°C	-	1.95	2.25	V	
	(terminal)		Tj=125°C	-	2.15	-		
Forward on voltage	(terrillial)		Tj=150°C	-	2.15	-		
Forward on voltage	VF		Tj=25°C	-	1.80	1.95		
			Tj=125°C	-	2.05	-		
	(chip)		Tj=150°C	-	2.05	-		
Reverse recovery time	trr	I _F = 300A		-	220	-	nsec	

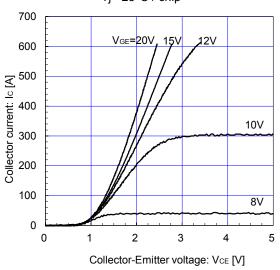
Thermal resistance characteristics

Items	Symbols	Conditions	Characteristics			Units
items	Syllibols	Conditions	min.	typ.	max.	Units
Thermal registance (Adevice)	Rth(j-c)	IGBT	-	-	0.045	°C/W
Thermal resistance (1device)		FWD	-	-	0.094	
Contact thermal resistance (1device) (*4)	Rth(c-f)	with Thermal Compound	-	0.0125	-	

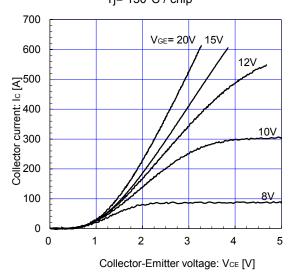
Note *4: This is the value which is defined mounting on the additional cooling fin with thermal compound.

■ Characteristics (Representative)

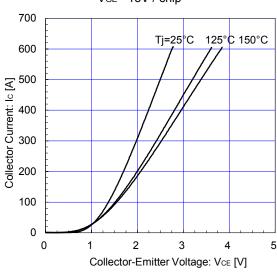
Collector current vs. Collector-Emitter voltage (typ.) Tj= 25°C / chip



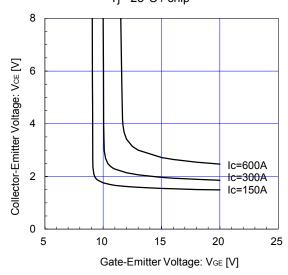
Collector current vs. Collector-Emitter voltage (typ.) Tj= 150°C / chip



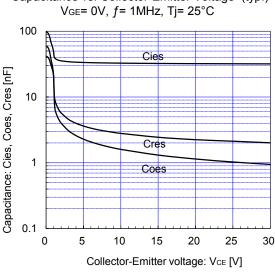
Collector current vs. Collector-Emitter voltage (typ.) VGE= 15V / chip



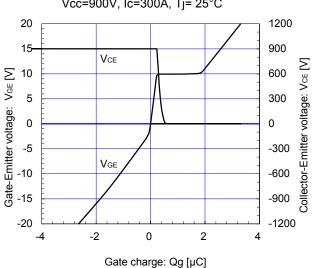
Collector-Emitter voltage vs. Gate-Emitter voltage Tj= 25°C / chip



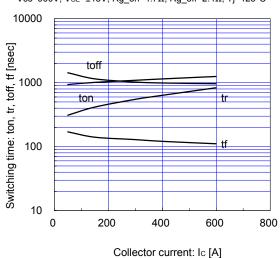
Capacitance vs. Collector-Emitter Voltage (typ.)



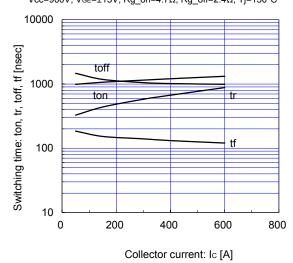
Dynamic Gate Charge (typ.) Vcc=900V, Ic=300A, Tj= 25°C



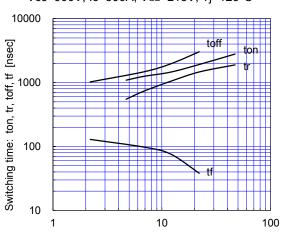
Switching time vs. Collector current (typ.) Vcc=900V, VcE=±15V, Rg_on=4.7Ω, Rg_off=2.4Ω, Tj=125°C



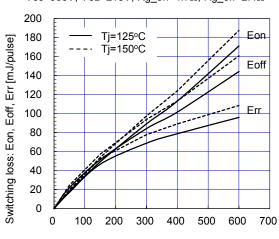
Switching time vs. Collector current (typ.) Vcc=900V, VcE=±15V, Rg_on=4.7Ω, Rg_off=2.4Ω, Tj=150°C



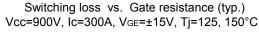
Switching time vs. Gate resistance (typ.) Vcc=900V, Ic=300A, V_{GE}=±15V, Tj=125°C

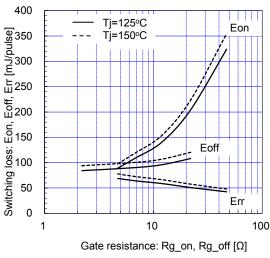


Transient Thermal Resistance (max.) Vcc=900V, VgE= \pm 15V, Rg_on= 4.7Ω , Rg_off= 2.4Ω



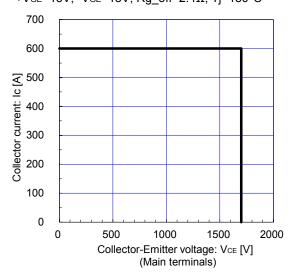
Gate resistance: Rg_on, Rg_off [Ω]

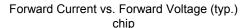


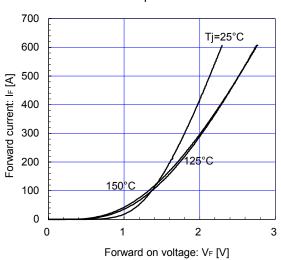


Reverse bias safe operating area (max.) $+V_{GE}=15V$, $-V_{GE}=15V$, $Rg_{off}=2.4\Omega$, $Tj=150^{\circ}C$

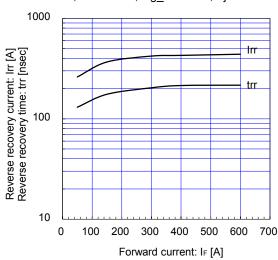
Collector current: Ic [A]



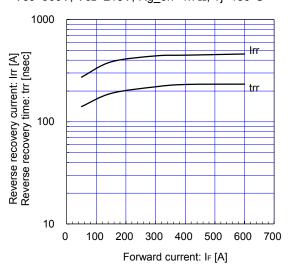




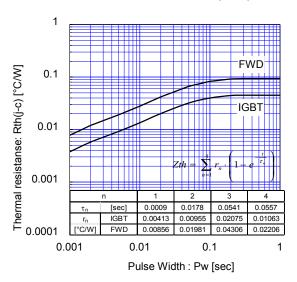
Reverse Recovery Characteristics (typ.) Vcc=900V, V_{GE}=±15V, Rg on=4.7Ω, Tj=125°C



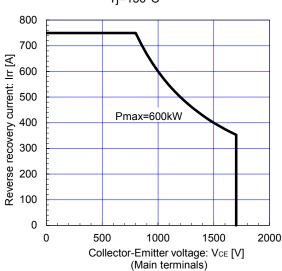
Reverse Recovery Characteristics (typ.) Vcc=900V, $VgE=\pm15V$, $Rg_on=4.7\Omega$, Tj=150°C



Transient Thermal Resistance (max.)

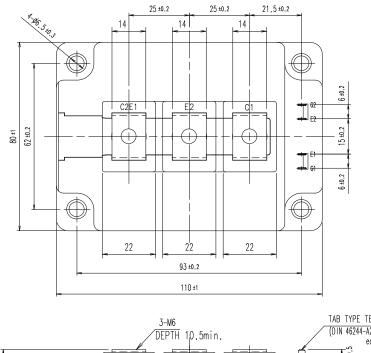


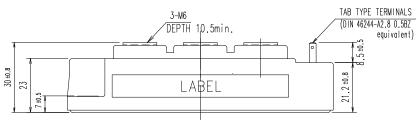
FWD safe operating area (max.) Tj=150°C



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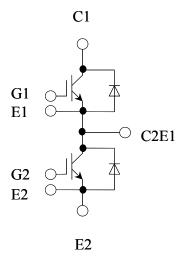
■ Outline Drawings (Unit: mm)





Weight: 470g (typ.)

■ Equivalent Circuit



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IGBT Modules

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